



EVERLIGHT ELECTRONICS CO.,LTD.

# DATA SHEET

**PART NO.** : 19-217/Y5C-AP1Q2/3T

**DATE** : 2003/9/27

**DEPARTMENT** : R&D 3

**REVISION** : 1.0

<b>RECEIVED</b>			
<input checked="" type="checkbox"/> <b>MASS PRODUCTION</b>			
<input type="checkbox"/> <b>PRELIMINARY</b>			
<input type="checkbox"/> <b>CUSTOMER DESIGN</b>			
<b>DEVICE NUMBER :</b> DSE-197-Y01			
<b>PAGE :</b> 10			
<b>CUSTOMER</b>	<b>DESIGNER</b>	<b>CHECKER</b>	<b>APPROVER</b>
	Jeff Tsai	Charles Chang	

<b>1.0</b>		<b>2003/9/27</b>
<b>REV.</b>	<b>DESCRIPTION</b>	<b>RELEASE DATE</b>

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**Package Type:**

SMD For PCB Type

11-21	19-215
12-21	19-215A
12-215	19-217A
15-21	22-21
15-215	23-21
16-213	23-21B
17-21	24-21
17-215	25-21
19-21	27-21
19-21A	42-21

**Dominant Wavelength Groups:**

According to the difference wavelength to define  
 None: No definition  
 A : Standard wavelength definition.  
 B : Range of wavelength definition is more narrowly than group A.  
 C : Range of wavelength definition is more narrowly than group A, but the value is different with group B.  
 F : The wavelength definition in special specification.

The dominant wavelength data did not including ±1nm testing tolerance.

**Test Forward Current:**

None: 20 mA  
 Y : 5 mA  
 Z : 10 mA

**Taping Quantity:**

- 1: 1000 pcs (Taping)
- 2: 2000 pcs (Taping)
- 3: 3000 pcs (Taping)
- 5: 5000 pcs (Taping)
- C : 1500 pcs (Taping)
- D : 10000 pcs (Taping)

**Packing Method :**

- A: Reverse-side placement (Anode toward the sprocket hole)
- B: Reverse-side placement (Anode toward the sprocket hole)
- C: Right-side placement
- D: Right-side placement (Anode toward the sprocket hole)
- T: Top-side placement
- R: Top-side placement (Anode toward the sprocket hole)

19 - 21 / B H C - A N1 P2 M / 3 T

**Emission Color:**

- R: Red (λ d: 640nm, 630nm, 625nm)
- S: Sunset Orange (λ d: 615nm, 605nm)
- Y: Yellow (λ d: 595nm, 590nm)
- G: Green (λ d: 570nm, 565nm, 560nm, 525nm, 505nm)
- B: Blue (λ d: 470nm)
- W: White x=0.32 y=0.31

The ordinal number that base on diffece electro-optical characteristics within chip.

1,2 ..... 7,8,9, A,B.....X,Y,Z

**Resin Color:**

- C: Water Clear
- W: White Diffused
- D: Diffused

**Luminous Intensity Groups:**

- |                   |                     |
|-------------------|---------------------|
| C0: 0.28 ... 0.45 | R ⇨ R1: 112 ... 140 |
| D0: 0.45 ... 0.70 | R2: 140 ... 180     |
| E0: 0.70 ... 1.1  | S1: 180 ... 225     |
| F0: 1.1 ... 1.8   | S2: 225 ... 285     |
| G0: 1.8 ... 2.8   | T1: 285 ... 360     |
| H0: 2.8 ... 4.5   | T2: 360 ... 450     |
| J0: 4.5 ... 7.2   | U1: 450 ... 565     |
| K0: 7.2 ... 11.5  | U2: 565 ... 715     |
| L1: 11.5 ... 14.5 | V1: 715 ... 900     |
| L2: 14.5 ... 18.0 | V2: 900 ... 1120    |
| M1: 18.0 ... 22.5 | W1: 1120 ... 1420   |
| M2: 22.5 ... 28.5 | W2: 1420 ... 1800   |
| N1: 28.5 ... 36.0 | X1: 1800 ... 2250   |
| N2: 36.0 ... 45.0 | X2: 2250 ... 2850   |
| P1: 45.0 ... 57.0 | Y1: 2850 ... 3600   |
| P2: 57.0 ... 72.0 | Y2: 3600 ... 4500   |
| Q1: 72.0 ... 90.0 |                     |
| Q2: 90.0 ... 112  |                     |

Unit: mcd

The luminous intensity data did not including ±15% testing tolerance.

**Forward Voltage Groups:**

None: No definition

The VF definition as follows:

		Unit: V			
Forward Voltage Group	Bin	Min.	Max.		
C	0	1.55	1.75		
	1	1.75	1.95		
	2	2.15	2.35		
	3	2.35	2.55		
	4	2.55	2.75		
M	5	2.75	3.05		
	6	3.05	3.35		
	7	3.35	3.65		
	8	3.65	3.95		
N	9	2.50	2.70		
	10	2.70	2.90		
	11	2.90	3.10		
	12	3.10	3.30		
	13	3.30	3.50		
	14	3.50	3.70		
	P	15	2.70	2.85	
		16	2.85	3.00	
		17	3.00	3.15	
		18	3.15	3.30	

The forward voltage data did not including ±0.1V testing tolerance.

# ANNEX



EVERLIGHT ELECTRONICS CO., LTD.

REV.: 2.0

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■ Dominant Wavelength Groups:

Y1,Y2,Y5		Range			
Dom . Wavelength Groups		Bin	Min.	Max.	Unit
A	C	D3	585.5	588.5	nm
		D4	588.5	591.5	nm
		D5	591.5	594.5	nm

Y3		Range			
Dom . Wavelength Group		Bin	Min.	Max.	Unit
A		D4	588.5	591.5	nm
		D5	591.5	594.5	nm
		D6	594.5	597.5	nm
		D7	597.5	600.5	nm

■ Forward Voltage Groups:

Forward Voltage Groups				Range					
				Bin	Min.	Max.	Unit		
A	B	C	A	00	1.55	1.75	V		
				0	1.75	1.95	V		
				1	1.95	2.15	V		
	D	E	M	D	2	2.15	2.35	V	
					3	2.35	2.55	V	
					4	2.55	2.75	V	
		J	R	K	J	5	2.75	3.05	V
						6	3.05	3.35	V
						7	3.35	3.65	V
H	P	N	F	K	8	3.65	3.95	V	
					9	2.50	2.70	V	
					10	2.70	2.90	V	
					11	2.90	3.10	V	
					12	3.10	3.30	V	
V	H	P	H	H	13	3.30	3.50	V	
					14	3.50	3.70	V	
V	H	P	H	H	15	2.70	2.85	V	
					16	2.85	3.00	V	
					17	3.00	3.15	V	
					18	3.15	3.30	V	



## Technical Data Sheet

### 0.4mm Height Flat Top LED

19-217/Y5C Series

#### Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.

#### Descriptions

- The 19-217 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

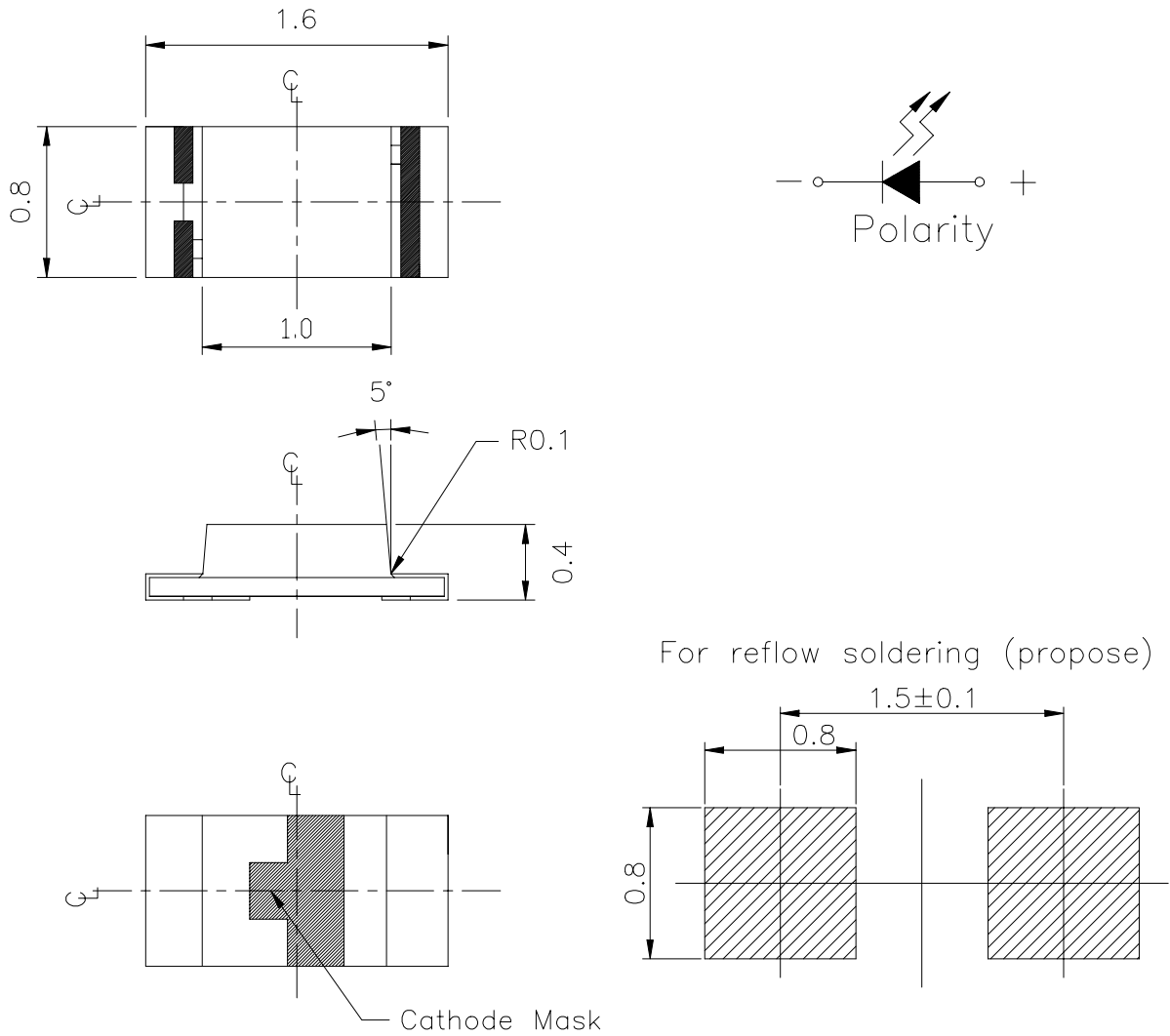
#### Applications

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

#### Device Selection Guide

Part No.	Chip		Lens Color
	Material	Emitted Color	
19-217/Y5C	AlGaInP	Brilliant Yellow	Water Clear

**Package Outline Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1\text{mm}$  , Angle  $\pm 0.5^\circ$  ,Unit = mm

**Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Unit
Reverse Voltage	V <sub>R</sub>	5	V
Forward Current	I <sub>F</sub>	25	mA
Operating Temperature	T <sub>opr</sub>	-40 ~ +85	°C
Storage Temperature	T <sub>stg</sub>	-40 ~ +90	°C
Soldering Temperature	T <sub>sol</sub>	260 (for 5 seconds)	°C
Electrostatic Discharge	ESD	2000	V
Power Dissipation	P <sub>d</sub>	100	mW
Peak Forward Current (Duty 1/10 @ 1KHz)	I <sub>F</sub>	60	mA

**Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Peak Wavelength	$\lambda_p$	----	591	----	nm	I <sub>F</sub> =20mA
Dominant Wavelength	$\lambda_d$	----	589	----	nm	
Spectrum Radiation Bandwidth	$\Delta\lambda$	----	15	----	nm	
Viewing Angle	2 $\theta$ 1/2	----	120	----	deg	
Forward Voltage	V <sub>F</sub>	----	2.0	2.4	V	
Reverse Current	I <sub>R</sub>	----	----	10	$\mu A$	V <sub>R</sub> =5V

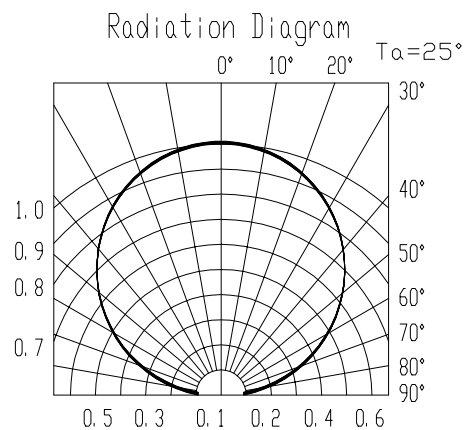
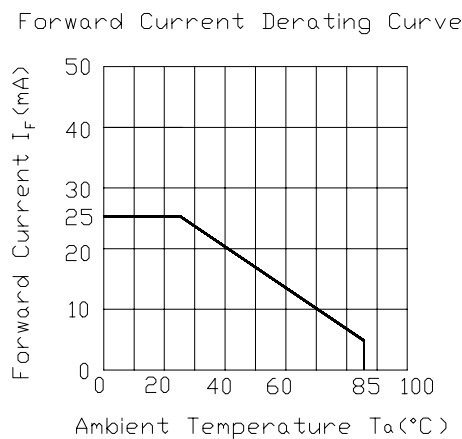
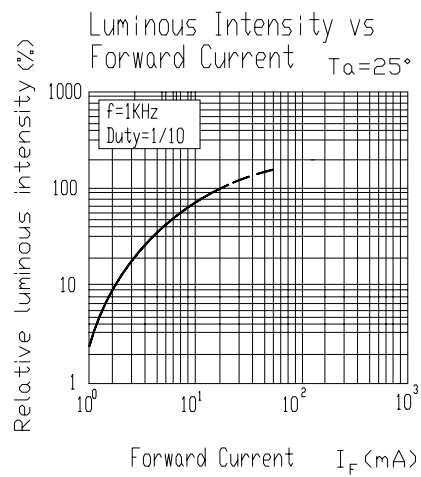
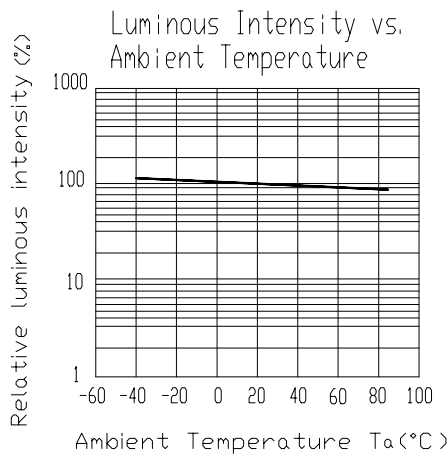
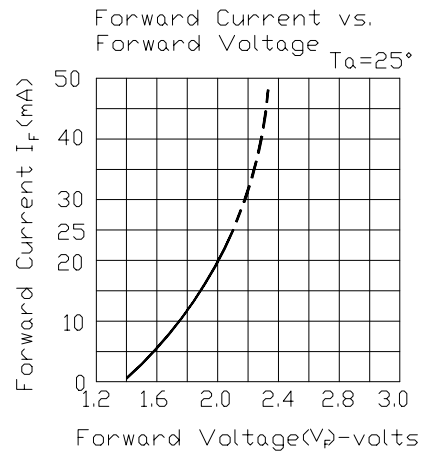
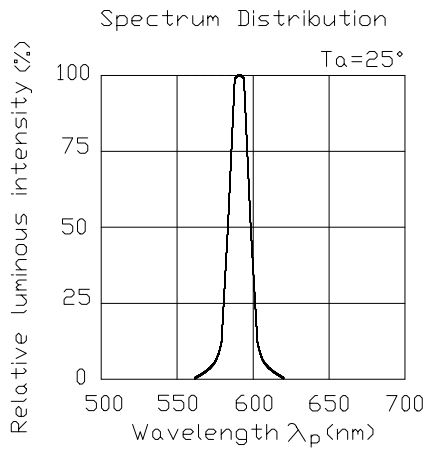
**19-217/Y5C Series**
**19-217/Y5C Series Explain Of Luminous Intensity:**
**IF=20mA**

Part No.	Parameter	Symbol	Typ.	Bin	Min.	Max.	Unit
19-217/Y5C-P1Q2	Luminous Intensity	Iv	75	P1	45.0	57.0	mcd
				P2	57.0	72.0	
				Q1	72.0	90.0	
				Q2	90.0	112	
19-217/Y5C-Q1R1	Luminous Intensity	Iv	100	Q1	72.0	90.0	mcd
				Q2	90.0	112	
				R1	112	140	
19-217/Y5C-Q2R2	Luminous Intensity	Iv	135	Q2	90.0	112	mcd
				R1	112	140	
				R2	140	180	

**Note:**

The luminous intensity data did not including  $\pm 15\%$  testing tolerance.

Typical Electro-Optical Characteristics Curves



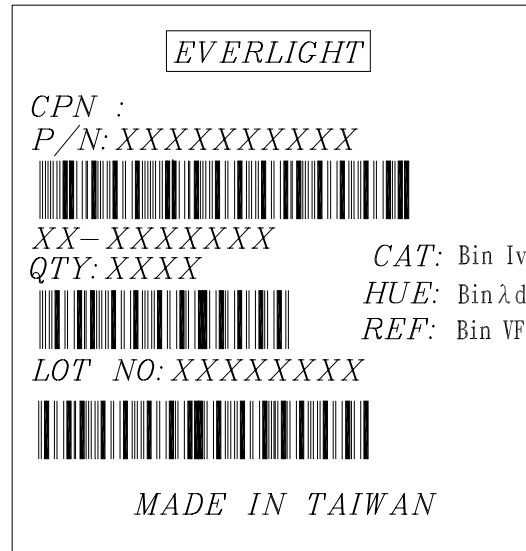


Label explanation

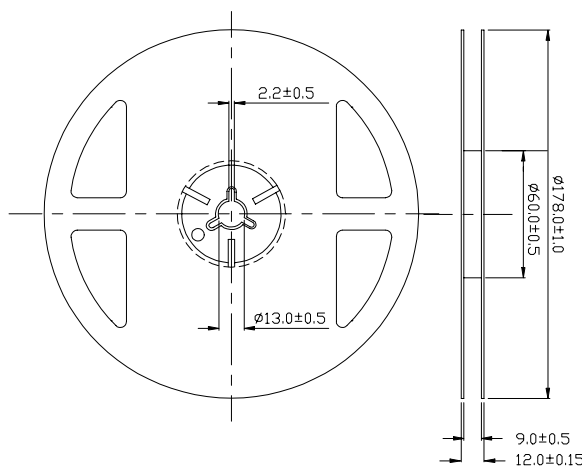
**CAT:** Luminous Intensity (mcd)

**HUE:** Dom. Wavelength (nm)

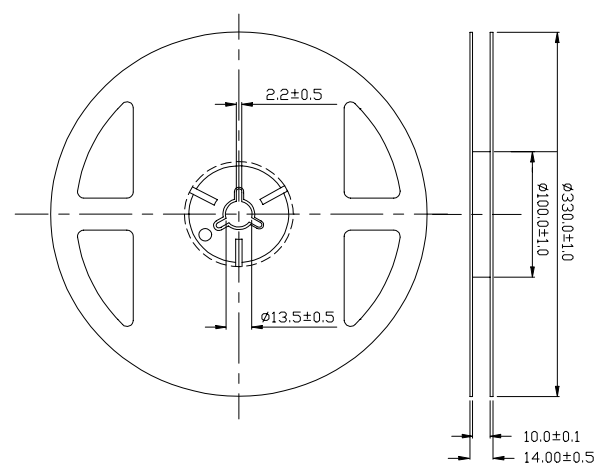
**REF:** Forward Voltage (V)



Reel Dimensions



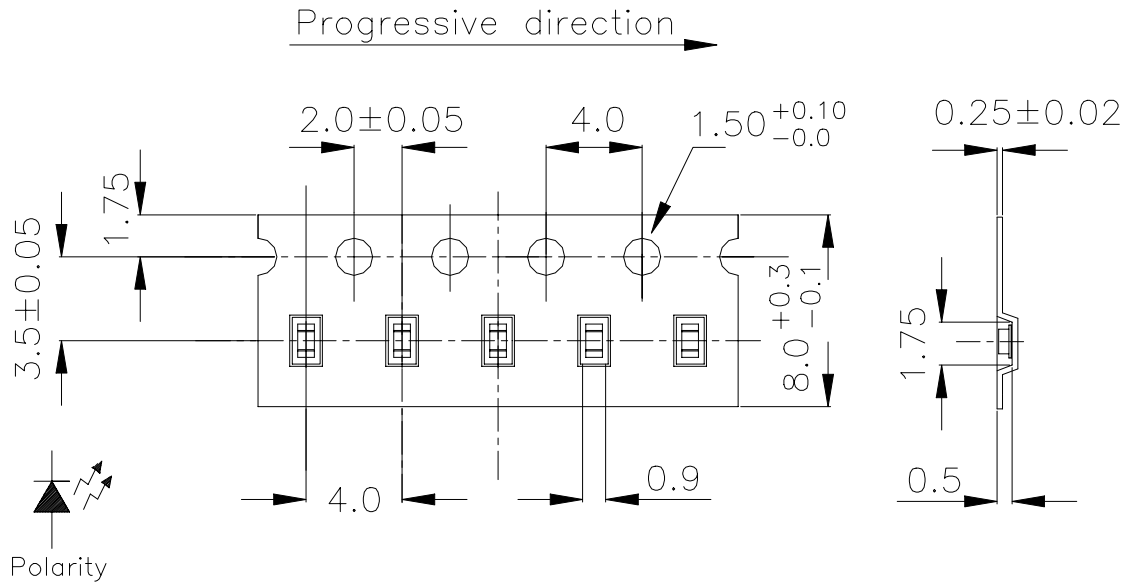
Taping Quantity: 3000pcs



Taping Quantity: 5000pcs & 10000pcs

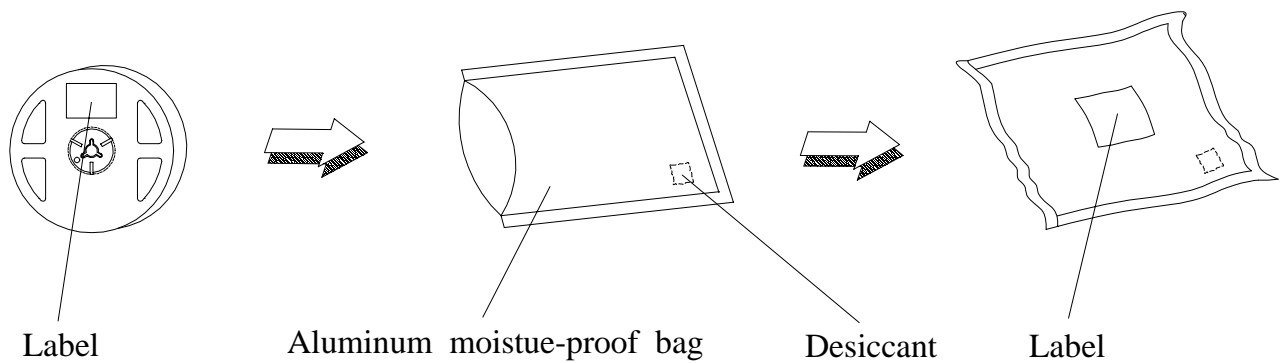
**Note:** The tolerances unless mentioned is  $\pm 0.1\text{mm}$  , Angle  $\pm 0.5^\circ$  ,Unit = mm

Carrier Tape Dimensions



Note: The tolerances unless mentioned is  $\pm 0.1\text{mm}$  , Angle  $\pm 0.5^\circ$  ,Unit = mm

Moisture Resistant Packaging



**Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level : 90 %

LTPD : 10 %

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow	Temp. : 240°C ± 5°C Min. 5 sec.	6 min.	22 Pcs.	0/1
2	Temperature Cycle	H : +100°C 15min. ∫ 5 min. L : -40°C 15min.	300 Cycles	22 Pcs.	0/1
3	Thermal Shock	H : +100°C 5min. ∫ 10 sec. L : -10°C 5min.	300 Cycles	22 Pcs.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 Pcs.	0/1
5	Low Temperature Storage	Temp. : -55°C	1000 Hrs.	22 Pcs.	0/1
6	DC Operating Life	IF = 20 mA	1000 Hrs.	22 Pcs.	0/1
7	High Temperature / High Humidity	85°C/R.H85%	1000 Hrs.	22 Pcs.	0/1

### Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change ( Burn out will happen ).

2. Storage time

2.1 The operation of Temperature and RH are : 5°C~35°C , RH60%.

2.2 Once the package is opened, the products should be used within a week.

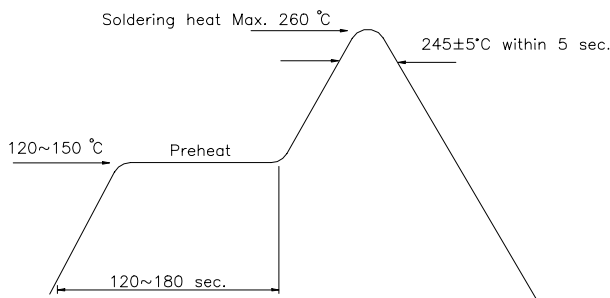
Otherwise, they should be kept in a damp proof box with descanting agent.

Considering the tape life , we suggest our customers to use our products within a year(from production date).

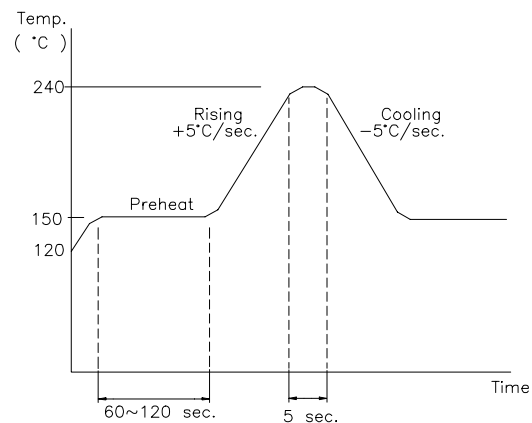
2.3 If opened more than one week in an atmosphere 5°C~35°C , RH 60%, they should be treated at 60°C± 5°C for 15hrs.

2.4 When you discover that the desiccant in the package has a pink color (Normal = blue) , you should treat them in the same conditions as 2.3.

### Soldering heat



### Reflow Temp / Time

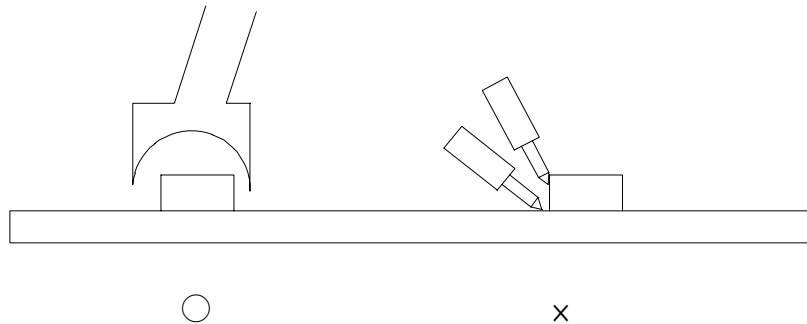
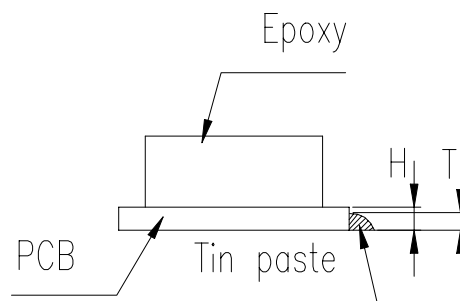


### Soldering Iron

Basic spec is  $\leq 5$  sec when 260°C. If temperature is higher, time should be shorter (+10°C → -1sec). Power dissipation of Iron should be smaller than 15 W , and temperature should be controllable. Surface temperature of the device should be under 230 °C.

**Rework**

1. Customer must finish rework within 5 sec under 245°C.
2. The head of iron can not touch copper foil.
3. Twin-head type is preferred.

**Thickness of tin paste**

Thickness:  
 $1/2H < T < H$

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